# **Electronic Acknowledgement Receipt** FES ID: 1147448 Application Number: 10699975 Confirmation Number: 5032 Mask layer and interconnect structure for dual damascene Title of Invention: semiconductor manufacturing First Named Inventor: Isaiah O. Oladeji Customer Number: 47396 Filer: Charles W. Gaines/Elizabeth Schumacher Filer Authorized By: Charles W. Gaines Attorney Docket Number: JESSEN 7-1-4 Receipt Date: 09-AUG-2006 Filing Date: 02-NOV-2003 Time Stamp: 14:12:20 Application Type: Utility International Application Number:

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ĺ	Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
	1	Request for Corrected Filing Receipt	Filing_Receipt.pdf	207703	no	3

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

#### National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/IDO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filling Receipt, in due course.